

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX244F, TC74LCX244FK

Low-Voltage Octal Bus Buffer with 5-V Tolerant Inputs and Outputs

The TC74LCX244 is a high-performance CMOS octal bus buffer. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

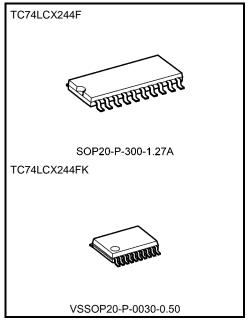
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

The TC74LCX244 is a non-inverting 3-state buffer having two active-low output enables. This device is designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation: $t_{pd} = 6.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min) (V}_{CC} = 3.0 \text{ V)}$
- Available in JEITA SOP, VSSOP (US)
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 244 type



Weight

SOP20-P-300-1.27A : 0.22 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

Note: The Electrical Characteristics of V_{CC} = 1.8 \pm 0.15 V is only applicable for products which manufactured from January 2009 onward.

Start of commercial production 1994-03

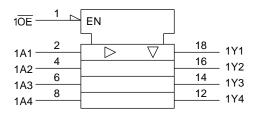
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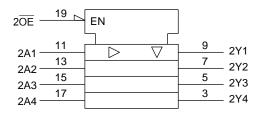


Pin Assignment (top view)

1OE 20 V_{CC} 1A1 19 2OE 1Y1 2Y4 3 18 1A2 2A4 2Y3 5 1Y2 1A3 6 15 2A3 2Y2 1Y3 7 1A4 2A2 8 1Y4 2Y1 9 GND 10 2A1

IEC Logic Symbol





Truth Table

Inputs		Outouto
ŌĒ	An	Outputs
L	L	L
L	Н	Н
Н	Х	Z

X: Don't care

Z: High impedance



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	VIN	–0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	
DC output voltage	Vout	-0.5 to V _{CC} + 0.5 (Note 3)	V
Input diode current	lıĸ	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	PD	180	mW
DC Vcc/ground current	ICC/IGND	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: VOUT < GND, VOUT > VCC

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit	
Dower aupply voltage	Voc	1.65 to 3.6	V	
Power supply voltage	Vcc	1.5 to 3.6 (Note 2)	V	
Input voltage	V _{IN}	0 to 5.5	V	
Output voltage	\/	0 to 5.5 (Note 3)	V	
Output voltage	Vout	0 to V _{CC} (Note 4)	V	
Output current	IOH/IOL	±24 (Note 5)	mA	
Output current	IOH/IOL	±12 (Note 6)	IIIA	
Operating temperature	T _{opr}	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either VCC or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: VCC = 3.0 to 3.6 V

Note 6: VCC = 2.7 to 3.0 V

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Note 7: VIN = 0.8 to 2.0 V, VCC = 3.0 V



Electrical Characteristics

DC Characteristics (Ta = -40 to 85°C)

Characteris	tion	Cumbal	Test Condition Vcc (V)		Min Max		l loit			
Characteris	ucs	Symbol			Vcc (V)	IVIII	Max	Unit		
					1.65 to 2.3	Vcc×0.9	_			
	H-level	VIH	_	_		1.7	_			
land to the sec					2.7 to 3.6	2.0	_			
Input voltage					1.65 to 2.3	_	Vcc×0.1	V		
	L-level	V _{IL}	_	-	2.3 to 2.7	_	0.7			
					2.7 to 3.6	_	0.8			
				ΙΟΗ = -100 μΑ	1.65 to 3.6	Vcc-0.2	_			
				I _{OH} = -4 mA	1.65	1.05	_			
	l l laval	Maria	Maria Maria an Maria	IOH = -8 mA	2.3	1.7	_			
	H-level	Voн	VIN = VIH or VIL	I _{OH} = -12 mA	2.7	2.2	_			
				I _{OH} = -18 mA	3.0	2.4	_			
Output walks as				IOH = -24 mA	3.0	2.2				
Output voitage	Output voltage			I _{OL} = 100 μA	1.65 to 3.6	_	0.2	V		
			VIN = VIH or VIL	I _{OL} = 4 mA	1.65	_	0.45			
	l			IOL = 8 mA	2.3		0.7			
	L-level	VoL		VIN = VIH or VIL	AIN = AIH OL AIL	VIN = VIH OI VIL	I _{OL} = 12 mA	2.7	_	0.4
					I _{OL} = 16 mA	3.0	_	0.4		
				I _{OL} = 24 mA	3.0	_	0.55			
Input leakage current	•	I _{IN}	V _{IN} = 0 to 5.5 V	V _{IN} = 0 to 5.5 V		_	±5.0	μА		
3-state output off-state	ate current I _{OZ}		V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА		
Power off leakage cur	ige current IOFF VI		VIN/VOUT = 5.5 V		0	_	10.0	μА		
			V _{IN} = V _{CC} or GND		1.65 to 3.6	_	10.0			
Quiescent supply curr	Quiescent supply current ICC VIN/VOUT = 3.6 to 5.5 V		5.5 V	1.65 to 3.6	_	±10.0	μА			
Increase in ICC per in	put	Δlcc	VIH = VCC - 0.6V	VIH = VCC - 0.6V (per 1 input)		_	500			



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition		Min	Max	Unit
Characteristics	Cymbol	rest condition	V _{CC} (V)	IVIIII	IVIAX	Offic
			1.8 ± 0.15	_	25.0	
Dranagation dalay time	tpLH	Figure 1, Figure 2	2.5 ± 0.2	_	8.5	no
Propagation delay time	tpHL	Figure 1, Figure 2	2.7	_	7.5	ns
			3.3 ± 0.3	1.5	6.5	
		Figure 1, Figure 3	1.8 ± 0.15	_	32.0	ns
Output analyse times	^t pZL t _{pZH}		2.5 ± 0.2	_	16.0	
Output enable time			2.7	_	9.0	
			3.3 ± 0.3	1.5	8.0	
	t _{pLZ}	Figure 1, Figure 3	1.8 ± 0.15	_	30.0	
Output Backla Care			2.5 ± 0.2	_	15.0	
Output disable time			2.7	_	8.0	ns
			3.3 ± 0.3	1.5	7.0	
Output to output skew	tosLH	(Note)	2.7	_	_	ns
	tosHL	(Note)	3.3 ± 0.3	_	1.0	

Note: Parameter guaranteed by design.

(tosLH = |tpLHm - tpLHn|, tosHL = |tpHLm - tpHLn|)

Dynamic Switching Characteristics (Ta = 25°C, input: tr = tf = 2.5 ns, CL = 50 pF, RL = 500 Ω)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic V _{OL}	VOLP	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V
Quiet output minimum dynamic VoL	Volv	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	_	3.3	7	pF
Output capacitance	Соит	_	3.3	8	pF
Power dissipation capacitance	CPD	f _{IN} = 10 MHz (No	te) 3.3	25	pF

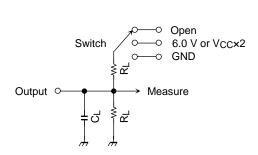
Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current

Average operating current can be obtained by the equation:

ICC (opr) = CPD \cdot VCC \cdot fIN + ICC/8 (per bit)



AC Test Circuit



Parameter	Switch		
t _{pLH} , t _{pHL}	Open		
* + 7 * 7	6.0 V	@ $V_{CC} = 3.3 \pm 0.3 \text{ V}$ @ $V_{CC} = 2.7 \text{ V}$	
tpLZ, tpZL	Vcc × 2	@ $V_{CC} = 2.5 \pm 0.2 \text{ V}$ @ $V_{CC} = 1.8 \pm 0.15 \text{ V}$	
t _{pHZ} , t _{pZH}		GND	

Figure 1



AC Waveform

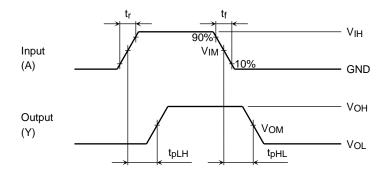


Figure 2 t_{pLH}, t_{pHL}

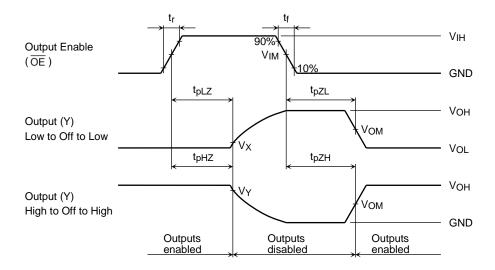


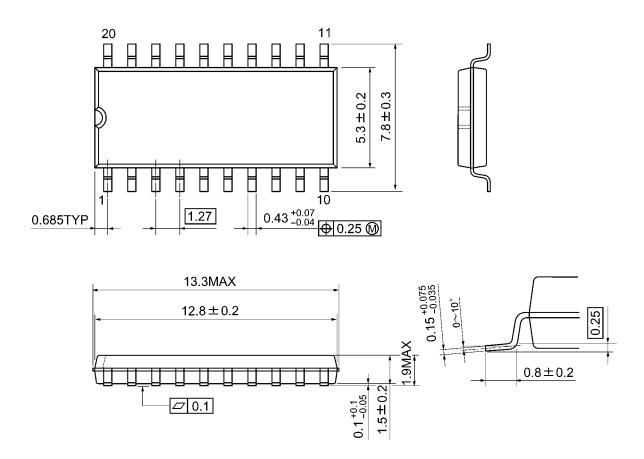
Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

		Vcc			
	Symbol	3.3 ± 0.3 V 2.7 V	2.5 ± 0.2 V	1.8 ± 0.15 V	
Input	VIH	2.7 V	Vcc	Vcc	
	VIM	1.5 V	Vcc/2	Vcc/2	
	t _r , t _f	2.5 ns	2.0 ns	2.0 ns	
Output	V _{OM}	1.5 V	V _{OH} /2	V _{OH} /2	
	VX	V _{OL} +0.3 V	V _{OL} +0.15 V	V _{OL} +0.15 V	
	VY	VoH -0.3 V	Vон -0.15 V	Vон -0.15 V	
Load	CL	50 pF	30 pF	30 pF	
	RL	500 Ω	500 Ω	1 kΩ	



Package Dimensions

SOP20-P-300-1.27A Unit: mm

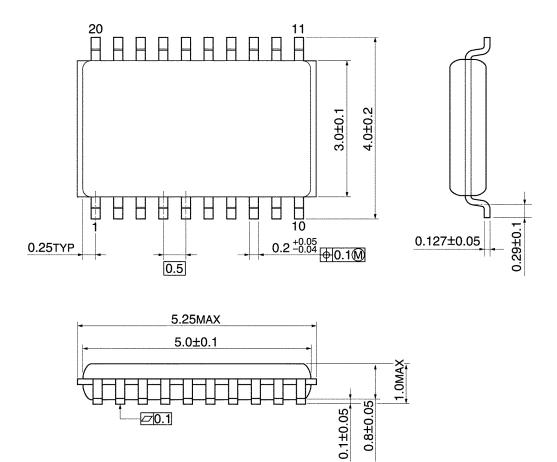


Weight: 0.22 g (typ.)



Package Dimensions

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)



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